

APPROVAL SHEET

WR02X(W)

$\pm 5\%$, $\pm 1\%$

RoHS compliant and Lead content 100ppm

General purpose chip resistors

Size 0201

*Contents in this sheet are subject to change without prior notice.

FEATURE

1. Small size and light weight
2. High reliability and stability
3. Reduced size of final equipment
4. Suitable for high density print circuit board assembly
5. Higher component and equipment reliability
6. RoHS compliant and Lead free product

APPLICATION

1. Mobile phone
2. PDA
3. Camcorders
4. Palmtop computers
5. Hybrid module

DESCRIPTION

The **LEAD FREE** resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a **LEAD FREE** resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (**LEAD FREE**) alloy.

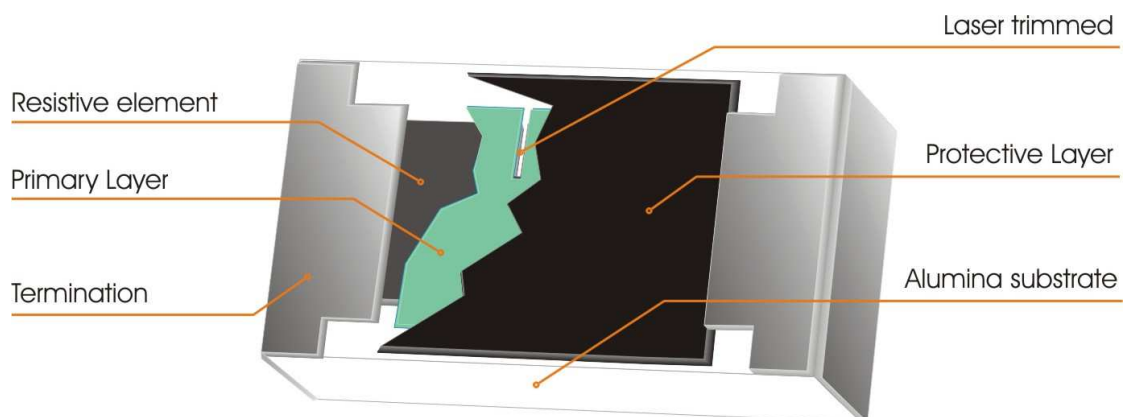


Fig 1. Construction of Chip-R WR02X

QUICK REFERENCE DATA

Item	General Specification	
Series No.	WR02X(W)	
Size code	0201(0603)	
Resistance Range	1Ω~10MΩ (±5% tolerance), Jumper 1Ω~1MΩ (±1% tolerance)	
Resistance Tolerance	±1% E96/E24	±5% E24
TCR (ppm/°C)	100Ω - 10MΩ, ±200 10Ω - 97.6Ω, +600 ~ 0 1 - 9.76Ω, +800~ -100	
Max. dissipation @ T _{amb} =70°C	1/20 W	
Max. Operation Voltage (DC or RMS)	25V	
Max. Overload Voltage (DC or RMS)	50V	
Climatic category (IEC 60068)	55/125/56	

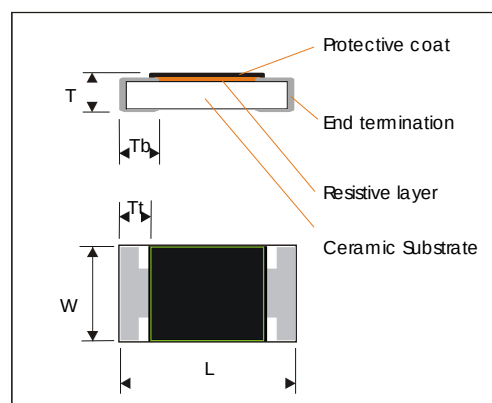
Note :

- This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

$$RCWV = \sqrt{\text{Rated Power} \times \text{Resistance Value}}$$
or Max. RCWV listed above, whichever is lower.

DIMENSION(unit : mm)

Type	WR02X(W)
L	0.60 ± 0.03
W	0.30 ± 0.03
T	0.23 ± 0.03
Tb	0.15 ± 0.05
Tt	0.10 ± 0.05

**MARKING**

WR02X(W) has no marking.

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of $\pm 5\%$ & $\pm 1\%$. The values of the E24/E96 series are in accordance with "IEC publication 60063"

Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

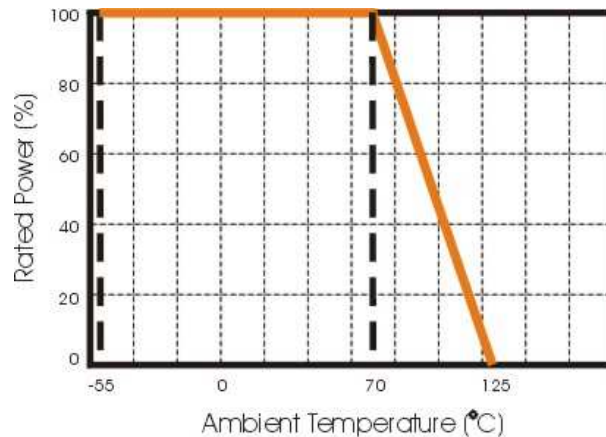


Figure 2. Maximum dissipation in percentage of rated power
As a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

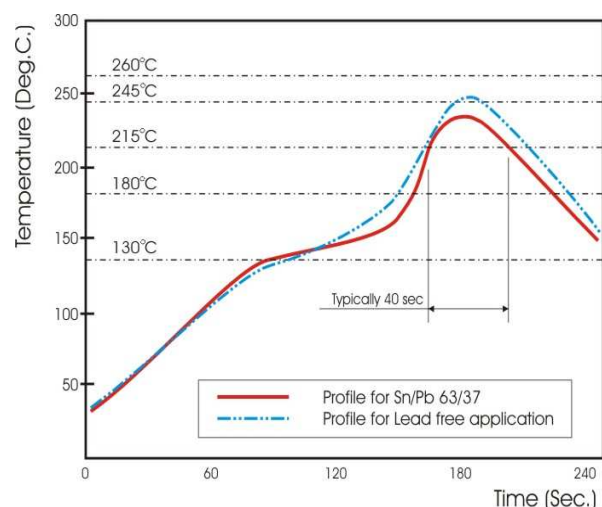


Fig 3. Infrared soldering profile for Chip Resistors WR02X(W)

CATALOGUE NUMBERS

The resistors have a catalogue number starting with :

WR02	X	472_	J	A	R
Size code WR02 : 0201	Type code X : Normal W : 1% For <10Ω and >1MΩ	Resistance code 5%, E24: 2 significant digits followed by no. of zeros 100Ω = 101_ 10KΩ = 103 1%, E24+E96: 3 significant digits followed by no. of zeros 100Ω = 1000 37.4KΩ = 3742	Tolerance J : ±5% F : ±1% P : Jumper	Packaging code A : 7" Reeled taping (15Kpcs/Reel)	RoHS code R = Lead free (< 100 ppm)

LEAD content: below 100ppm with reference to IEC62321, determination of LEAD by ICP-AES

TEST AND REQUIREMENTS (JIS C 5201-1 : 1998)

Essentially all tests are carried out according to the schedule of **IEC publication 115-8**, category **LCT/UCT/56**(rated temperature range : **Lower Category Temperature**, **Upper Category Temperature**; damp heat, long term, 56 days). **The testing also meets the requirements specified by EIA, EIAJ and JIS.**

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

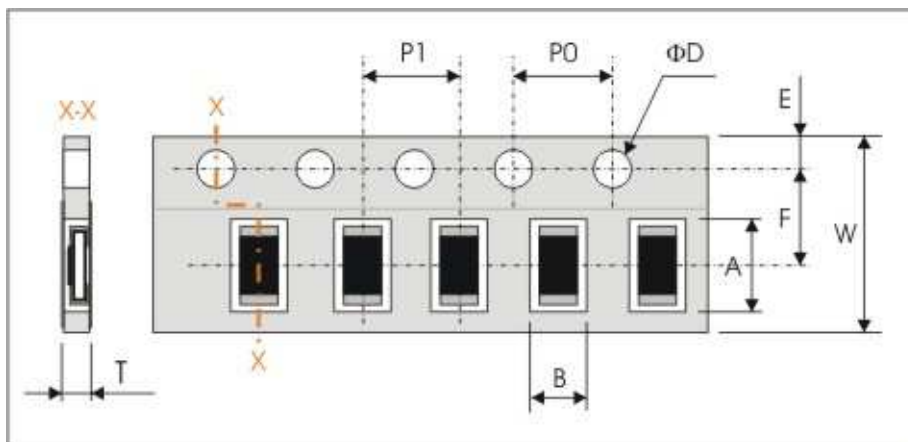
All soldering tests are performed with mildly activated flux.

TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
		Resistor	0Ω
DC resistance Clause 4.5	DC resistance values measured at the test voltages specified below : <10Ω@0.1V, <100Ω@0.3V, <1KΩ@1.0V, <10KΩ@3V, <100KΩ@10V, <1MΩ@25V, <10MΩ@30V	Within the specified tolerance	<50mΩ
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$ $t_1 : 20^\circ\text{C} + 5^\circ\text{C} - 1^\circ\text{C}$ R_1 : Resistance at reference temperature R_2 : Resistance at test temperature	Refer to "QUICK REFERENCE DATA"	N/a
Short time overload (S.T.O.L) Clause 4.13	Permanent resistance change after a 2second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	$\Delta R/R \text{ max. } \pm(1\% + 0.05\Omega)$	<50mΩ

Resistance to soldering heat(R.S.H) Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260°C±5°C	$\Delta R/R$ max. $\pm(1\%+0.05\Omega)$ no visible damage	<50m Ω
Solderability Clause 4.17	Un-mounted chips completely immersed for 2±0.8second in a SAC solder bath at 235°C±5°C	95% coverage min., good tinning and no visible damage	
Temperature cycling Clause 4.19	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30 minutes at +125°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	$\Delta R/R$ max. $\pm(1\%+0.05\Omega)$	< 50m Ω
Damp Heat (Load life in humidity) Clause 4.24	1000 +48/-0 hours, loaded with RCWV or V _{max} in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	$\Delta R/R$ max. $\pm(5\%+0.10\Omega)$	< 50m Ω
Load Life (Endurance) Clause 4.25	1000+48/-0 hours; loaded with RCWV or V _{max} in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	$\Delta R/R$ max. $\pm(5\%+0.10\Omega)$	< 50m Ω
High temperature Clause 4.25	125°C x 1000hrs, no load	$\Delta R/R$ max. $\pm(5\%+0.10\Omega)$	< 50m Ω
Bending strength Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 3mm for 10sec.	No visual damaged, $\Delta R/R$ max. $\pm(1\%+0.05\Omega)$	< 50m Ω
Adhesion Clause 4.32	Pressurizing force: 3N, Test time: 10±1sec.	No remarkable damage or removal of the terminations	

PACKAGING

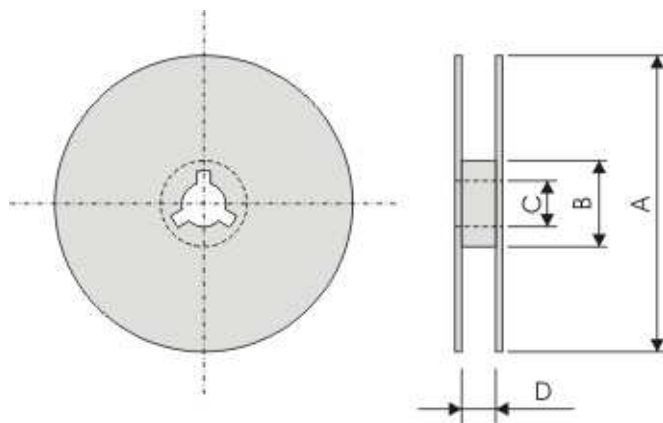
Paper Tape specifications (unit :mm)



Series No.	A	B	W	F	E
WR02X	0.67±0.05	0.37±0.05	8.00±0.20	3.50±0.05	1.75±0.10

Series No.	P1	P0	ΦD	T
WR02X	2.00±0.05	4.00±0.05	Φ1.50 ^{+0.1} _{-0.0}	0.45±0.05

Reel dimensions



Symbol	A	B	C	D
(unit : mm)	Φ180.0+0/-1.5	Φ60.0±1.0 Φ60.0+1/-0	13.0±0.2	9.0+1/-0

Taping quantity and Tape material

- Chip resistors 15,000 pcs/reel, Paper tape.